Overview

HP ProBook 450 15.6" G9 Notebook PC



- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. Camera Shutter
- 4. Combo Web/IR Camera (Optional)

Left

- 5. Clickpad
- 6. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 7. Ethernet Port (RJ-45)
- 8. Nano Security Lock Slot (Lock sold separately)



Overview



Right

- 1. Power Button Key
- 2. Power Connector
- 3. SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
- 4. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 5. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 6. HDMI 2.1 Port (Cable not included)
- 7. Audio Combo Jack
- 8. External SIM (WWAN Optional Model)
- 9. Touch Fingerprint Sensor (Select Models)



QuickSpecs

Overview

AT A GLANCE

- Preinstalled with Windows 11 versions or FreeDOS
- Choice of 12th generation Intel[®] Core™ i7, i5 and i3 processors
- NVIDIA[®] GeForce[®] MX570 discrete graphics with 2 GB GDDR6 video memory
- NVIDIA[®] GeForce[®] MX570A discrete graphics with 2 GB GDDR6 video memory
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 1 TB, 2nd SSD 128GB/256GB (Optional)
- Multi-layered security with HP SureStart Gen6, HP Priva7y Camera, HP Sure View Gen4¹, HP Sure Sense G2, HP Sure Click, and Touch Fingerprint reader², Tamper Lock, HP Wolf Security
- Supports wireless options for connectivity on the go including gigabit-speed up to Wi-Fi® 6E and CAT16 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles³
- Designed to support HP docking options
- Passed MIL-STD 810H tests⁴
- Battery options 42.75 Wh and 51.3 Wh
- Battery life up to 12 hours and 15 minutes
- Optimize your video calls with an HD camera and Temporal Noise Reduction that adjusts to the lighting in your environment.

1. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

2. Sold separately or as an optional feature.

3. HP notebooks up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

4. MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP ProBook 450 15.6" G9 Notebook PC

OPERATING SYSTEM

 Preinstalled
 Windows 11 Pro 1

 Windows 11 Pro Education 1
 Windows 11 Pro Education 1

 Windows 11 Home - HP recommends Windows 11 Pro for business 1
 Windows 11 Home Single Language - HP recommends Windows 11 Pro for business 1

 Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement) 1
 Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) 1.2

 FreeDOS
 FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

Processor ^{3,4,5,6}	Numb Cores of	Number of	er Number of	Threads	L3 Cache	Max Turbo Frequency		Base Frequency	
		P-cores	E-cores			P-cores	E-cores	P-cores	E-cores
Intel® Core™ i7- 1260P	12	4	8	16	18MB	4.7 GHz	3.4 GHz	2.1 GHz	1.5 GHz
Intel® Core™ i5- 1240P	12	4	8	16	12MB	4.4 GHz	3.3 GHz	1.7 GHz	1.2 GHz
Intel® Core™ i7- 1255U	10	2	8	12	12MB	4.7 GHz	3.5 GHz	1.7 GHz	1.2 GHz
Intel [®] Core™ i5- 1235U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.3 GHz	0.9 GHz
Intel® Core™ i3- 1215U	6	2	4	8	10MB	4.4 GHz	3.3 GHz	1.2 GHz	0.9 GHz
Intel [®] Pentium [®] Gold 8505	5	1	4	6	8MB	4.4 GHz	3.3 GHz	1.2 GHz	0.9 GHz
Intel [®] Celeron [®] 7305	5	1	4	6	8MB	N/A	N/A	1.1 GHz	0.9 GHz

PROCESSORS

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application



QuickSpecs

Technical Specifications

workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel[®] Iris[®] X Graphics (Core i5 and Core i7)⁷ Intel[®] UHD Graphics (Core i3)

Discrete

NVIDIA GeForce ®MX570 Controller NVIDIA GeForce ®MX570A Controller

Support

Support HD decode, DX12, HDMI 2.1 8

7. Intel[®] Iris[®] X^e Graphics capabilities require system to be configured with Intel[®] Core[™] i5 or i7 processors and dual channel memory. Intel[®] Iris[®] X^e Graphics with Intel[®] Core[™] i5 or 7 processors and single channel memory will only function as UHD graphics.

8. HD content required to view HD images.

DISPLAY

Non-Touch

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, low power narrow bezel bent, 400 nits, 100% sRBG for HD TNR camera (1920 x 1080)^{8,9}

39.6 cm (15.6") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel bent, 400 nits, 100% sRGB for HD+IR camera (1920 x 1080)^{8,9}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1920 x 1080)^{8,9} 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera (1920 x 1080)^{8,9}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080)^{8,9}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera and WWAN (1920 x 1080) ^{8,9}

39.6 cm (15.6") diagonal HD SVA eDP + PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1366 x 768) ^{8,9}



39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera (1366 x 768)^{8,9} 39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD+IR camera (1366 x 768)^{8,9} 39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera and WWAN (1366 x 768)^{8,9}

Touch

39.6 cm (15.6") diagonal FHD UWVA eDP + PSR anti-glare, narrow bezel bent, touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080) ^{8,9,10,11}

39.6 cm (15.6") diagonal FHD UWVA eDP + PSR anti-glare, narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080) ^{8,9,10,11}

HDMI

Support resolutions up to 4k 60Hz

Display Size

15.6" diagonal 39.6 cm (15.6") diagonal

8. HD content required to view HD images.
9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
10. Sold separately or as an optional feature.
11. Actual brightness will be lower with touchscreen or HP Sure View.

DOCKING (Sold Separately)

Docking station model #1	HP USB-C Dock G5	
Docking station model #2	HP USB-C/A Universal Dock G2	
Docking station model #3	HP Thunderbolt Dock G2	
For additional aftermarket options and docking specs please see page 38.		

STORAGE AND DRIVES

Primary M.2 Storage

1 TB PCIe® NVMe[™] M.2 TLC Solid State Drive ¹² 512 GB PCIe® NVMe[™] M.2 Value Solid State Drive ¹² 256 GB PCIe® NVMe[™] M.2 Value Solid State Drive ¹² 128 GB PCIe® NVMe[™] M.2 Value Solid State Drive ¹²

Secondary M.2 Storage

256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹³ 128 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹³

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

13. Second storage is only available with non-WWAN base Unit AND Primary M.2 storage.



MEMORY

Maximum Memory 32 GB DDR4-3200 SDRAM ¹⁴

Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (1 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹⁴ 12 GB DDR4- 3200 SDRAM (1 x 4 GB + 1 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (1 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (2 x 4 GB) ¹⁴ 4 GB DDR4-3200 SDRAM (1 x 4 GB) ¹⁴

Memory Slots

2 SODIMM

Both slots are accessible/upgradeable by IT or self-maintainers only. DDR4 PC4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi6E +Bluetooth® 5.3 M.2 2230 160MHz CNVi World-Wide WLAN $^{\rm 15}$ Realtek 8852BE Wi-Fi 6 + Bluetooth® 5.3 M.2 2230 PCI-e+USB World-Wide WLAN $^{\rm 16}$

WWAN

Intel[®] XMM 7560 R+ LTE-Advanced Pro Cat 16¹⁷

Miracast Native Miracast Support

Ethernet Realtek RTL8111HSH 10/100/1000 Integrated NIC ¹⁸

Wake on WLAN

Support on S3 AC mode only

15. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
16. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6™ is designed to support gigabit data rate when



transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

17. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

18. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power 2W/40hm per speaker

Camera

720p HD camera with Temporal Noise Reduction ⁹ 720p HD camera+IR Camera ^{8,10}

8. HD content required to view HD images. 10. Sold separately or as an optional feature.



KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, full-size, spill resistant with numeric keypad and optional backlit ¹⁹

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle F10 - Insert
- F11 Airplane Mode F12 - Programmable key
- Print Screen
- Power Button (with LED)

Hidden Function Keys

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock

19. Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

Software

HP Quick Drop²⁰ HP PC Hardware Diagnostics Windows myHP HP Smart Support ²¹ HP Connection Optimizer HP Hotkey Support HP Support Assistant ²² HP Notifications HP Power Manager HP Privacy Settings Buy Microsoft Office (Sold separately)

Manageability Features

HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)²³ HP Client Management Script Library (download) HP Driver Packs (download) HP Client Catalog (download)

NOTE: To enhance brightness, level go to the Intel[®] Graphics Command Center app, click on System and turn off the Display Power Savings function.

Security Management

HP Wolf Security of Business²⁴ includes: HP Sure Click²⁵ HP Sure Sense2²⁶ HP Sure Start Gen7²⁷ HP Tamper Lock HP Sure Admin²⁸ HP Client Security Manager Gen7²⁹

BIOS

HP BIOSphere Gen6 ³⁰ HP Secure Erase ³¹ Absolute Persistence Module ³² HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLAN TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) HP Fingerprint Sensor ³³

Security

TPM Model: Nuvoton NPCT760HAAYX Version: 7.2.3.0 Revision: TPM 2.0 FIPS 140-2 Compliant: Yes



IPv6 Support

твс

FirstNet Certified

No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: 3

20. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

21. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

22. HP Support Assistant requires Windows and Internet Access

23. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

24. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

25. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

26. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

27. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

28. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

29. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

30. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

31. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane™.

32. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

33. HP Fingerprint Reader is an optional feature that must be configured at purchase.



POWER

Power Supply

HP Smart 65 W External AC power adapter ³⁴ HP Smart 65 W EM External AC power adapter ³⁴ HP Smart 65 W USB Type-C adapter ³⁴ HP Smart 45 W External AC power adapter ³⁴ HP Smart 45 W USB Type-C adapter ³⁴

Battery

HP Long Life 3-cell, 42.75 Wh Polymer ^{35,36} HP Long Life 3-cell, 51.3 Wh Polymer ^{35,36} Compliant with UL 1642 Standard

Power Cord

3-wire plug – 1 ³⁴ 2-wire plug - 1 ³⁴

Battery life

Up to 12 hours and 15 minutes with 51 whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel U15, 200 nits display, 2*4G memory, 256 GB SSD)³⁷

Up to 12 hours and 15 minutes with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel P28, 200 nits display, 2*4G memory, 256 GB SSD) ³⁷

Up to 10 hours and 30 minutes with 42whr battery (HP Long Life 3-Cell, 42 Whr Polymer, UMA graphic, Intel U15, 200 nits display, 2*4G memory, 256 GB SSD) ³⁷

34. Availability may vary by country.

35. Battery is internal and not replaceable by customer. Serviceable by warranty.

36. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

37. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight 42.75Wh Starting at 3.83 lb ³⁸ Starting at 1.74 kg ³⁸

51.3 Wh Starting at 3.96 lb ³⁸ Starting at 1.79 kg ³⁸

Product Dimensions (W x D x H)

14.15 x 9.21 x 0.78 in 35.94 x 23.39 x 1.99 cm

38. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
 SuperSpeed USB Type-A 5Gbps signaling rate includes 1 charging, 1 powered port (USB 3.2 Gen 1)
 HDMI 2.1 ³⁹
 RJ-45
 Headphone/microphone combo jack
 AC power
 External Nano SIM slot for WWAN (optional)

39. HDMI cable sold separately.



SERVICE AND SUPPORT

HP Services offers 1-year or 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.⁴⁰

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

Stand Alana Davies Dagwinamanta (AC Davies)	
Stand-Alone Power Requirements (AC Power)	19V
Nominal Operating Voltage	
Average Operating Power	U15 UMA 3.72W/U15 DSC 4.56W/U28 3.80W
Integrated graphics	Yes
Discrete Graphics	Yes, GN20-S5
Max Operating Power	Discrete < 65W
T	UMA U15 < 45W, UMA U28 < 65W
Temperature	32° to 95° F (0° to 35° C)
Operating	
	(No sustained direct exposure to sunlight) (System performance may be reduced above 32°C (89.6°F))
Non encurting	
Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	100/ to 000/ non condensing
Operating Non-operating	10% to 90%, non-condensing
Non-operating	5% to $95%$
Charle	(38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)
Shock	
Operating Non-operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	1.042
Operating Non-operating	1.043 grams
Non-operating	3.5 grams
Altitude (unpressurized)	10,000 ft (2,040 m)
Operating	10,000 ft (3,048 m)
Non-operating	40,000 ft (12,192 m)
Planned Industry Standard Certifications	
Regulatory Model Number	HSN-Q32C-5
UL CSA	Yes
FCC Compliance	Yes
ENERGY STAR [®]	Yes Yes ⁴¹
EPEAT®	EPEAT [®] Gold in the United States ⁴²
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
	Yes
Japan VCCI Compliance	Yes
KC	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	
	Yes
CIT	Yes
EAC	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes
UKRSERTCOMPUTER	Yes



QuickSpecs

Technical Specifications

41. Configurations of the HP ProBook 450 G9 that are ENERGY STAR[®] qualified are identified as HP ProBook 450 G9 ENERGY STAR on HP websites and on http://www.energystar.gov.

42. Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

Panel LCD 15.6 inch FHD	Outline Dimensions (W x H)	350.960 x 205.740 mm (max)
(1920 x 1080) Anti-Glare WLED	Active Area	344.160 x 193.590 mm (typ.)
UWVA 45percent cg 250nits eDP	Weight	380 g (max)
1.2 w/o PSR bent Touch on Panel	Diagonal Size	15.6 inch
NWBZ	Thickness	3.2mm/ 5.2mm (PCB) (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare On-cell
	Touch Enabled	Yes ¹
	Contrast Ratio	600:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	LED
	Pixel Resolution	RGB Stripe
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 bits
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.54 (Max) / 3.12 (Max)

(1920 x 1080) Anti-Glare WLEDActive AreaUWVA sRGB 100percent cgWeight400nits eDP 1.4+PSR2 bent LPDiagonal SizeNWBZThiskness	344.160 x 193.590 mm (typ.) 325 g (max) 15.6 inch
Thickness	2.6mm / 4.6mm (PCB) (max)
Interface	eDP 1.4
Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	1200:1 (typ.)
Refresh Rate	60 Hz

Pixel Resolution - Format

Brightness

Backlight



400 nits

LED

1920 x 1080 (FHD)

lecinical Specification	15	
	Pixel Resolution	RGB Stripe
	Color Gamut Coverage	sRGB 100% (NTSC 72%)
	Color Depth	8 bits
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.13(Max)/1.37(Max)
Panel LCD 15.6 inch FHD	Outline Dimensions (W x H)	350.960 x 205.540mm (max)
(1920 x 1080) Anti-Glare WLED	Active Area	344.160 x 193.590 mm (typ.)
UWVA 45percent cg 250nits eDP	Weight	370 g (max)
1.2 w/o PSR bent NWBZ	Diagonal Size	15.6 inch
	Thickness	3.0 mm/ 5.0 mm (w/PCB) (max)
	Interface	eDP 1.2 (2 lane)
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	600:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	LED
	Pixel Resolution	RGB Stripe
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 bits (Hi FRC supportive w/ condition to enable)
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	Νο
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.62 (Max) / 3.27 (Max)
Panel LCD 15.6-in HD	Outline Dimensions (W x H)	350.960 x 205.540 mm (max)
(1366 x 768) Anti-Glare WLED	Active Area	344.230 x 193.540 mm (typ.)
SVA 45percent cg 250nits eDP	Weight	370 g (max)
1.2 w/o PSR NWBZ bent	Diagonal Size	15.6 inch
	Thickness	3.2 mm / 5.0 mm (w/PCB) (max)
	Interface	eDP 1.2 (1 lane)
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	300:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution - Format	1366 x 768 (HD)
	B	1.50

LED

Backlight

hp

Pixel Resolution	RGB Stripe
Color Gamut Coverage	NTSC 45%
Color Depth	6 bits
Viewing Angle	SVA 45/45/15/35
Low Blue Light	No
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.49 (Max) / 2.78 (Max)



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 128GB 2230 PCIe NVMe Value	Form Factor	M.2 2230
	Capacity	128GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.01 lb (5 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2100 MB/s
	Maximum Sequential Write	Up to 1200 MB/s
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2230 PCIe NVMe Value	Form Factor	M.2 2230
	Capacity	256 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCle NVMe Gen3
	Maximum Sequential Read	up to 2500 MB/s
	Maximum Sequential Write	up to 1300 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	256GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2900 MB/s
	Maximum Sequential Write	Up to 1400 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]



SSD 512GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	512GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 3500 MB/s
	Maximum Sequential Write	up to 3000 MB/s
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2
SSD 1TB 2280 PCIe-4x4 NVMe	Form Factor	M.2 2280
Three Layer Cell	Capacity	1TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4
	Maximum Sequential Read	Up to 7,100 MB/s
	Maximum Sequential Write	Up to 5,200 MB/s
	Logical Blocks	2,000,409,264
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Feetunee	Durito 2 0. TDIM. L1 2
	Features	Pyrite 2.0; TRIM; L1.2

hp

Technical Specifications

NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E and Wireless LAN Bluetooth® 5.3 M.2 160MHz CNVi WW WLAN non-vPro ¹	Standards IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11d IEEE 802.11d IEEE 802.11h IEEE 802.11h IEEE 802.11h IEEE 802.11h
Interoperabi	lity Wi-Fi certified
Frequency Ba	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps
Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
Security ³	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
Network Arc	
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Powe	r² • 802.11b : +17dBm minimum

	 802.11g: +16dBm minimum 802.11a: +17dBm minimum 802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +10dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum 		
Power Consumption	•Transmit mode2 •Receive mode1. •Idle mode (PSP)	2.0 W 6 W 180 mW(WLAN Associated) V(WLAN unassociated) dby 10mW	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ⁴	 802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11a, MCS07 : -67dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0(VHT80) : -84dBm maximum 802.11ac, MCS9(VHT80) : -59dBm maximum 802.11ac, MCS9(VHT80) : -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum 		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm		
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating	0 to 10,000 ft (3,048 m)	



	Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.	D/5.1/5.2/5.3 Wireless Technology
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3 (802.11ax 2x2, supporting gigabit data rate) ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11d IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11i IEEE 802.11v
	Interoperability Frequency Band	Wi-Fi certified modules •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz
	Data Rates	5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Madulatian	•802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac: max 866.7Mbps • 802.11ax: max 1201Mbps
	Modulation Security ³	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM •IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only
	Security	 AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	 802.11b : +18.5dBm minimum 802.11g : +17.5dBm minimum 802.11a : +18.5dBm minimum 802.11n HT20(2.4GHz) : +15.5dBm minimum 802.11n HT40(2.4GHz) : +14.5dBm minimum 802.11n HT20(5GHz) : +15.5dBm minimum



QuickSpecs

Technical Specifications

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			5GHz) : +14.5dBm minimum :0(5GHz) : +11.5dBm minimum
)(2.4GHz) : +10dBm minimum)(5GHz) : +10dBm minimum
	Power Consumption	• 802.1 Tax HE80	
	Power consumption	•Receive mode:2	
			180 mW(WLAN Associated)
			W(WLAN unassociated)
		•Radio disabled:	dby/Modern Standby: 10mW 8 mW
	Power Management	ACPI and PCI Exp	ress compliant power management
		802.11 compliar	it power saving mode
	Receiver Sensitivity ⁴	•	-93.5dBm maximum
		•	s: -84dBm maximum os: -86dBm maximum
			pps: -72dBm maximum
			: -67dBm maximum
			: -64dBm maximum
			-84dBm maximum -59dBm maximum
			11(HE40): -57dBm maximum
		•802.11ax, MCS1	I 1 (HE80): -54dBm maximum
	Antenna type	High efficiency a enclosure.	ntenna with spatial diversity, mounted in the display
			lual band 2.4/5 GHz antennas are provided to the card to
			IMO communications and Bluetooth communications
	Form Factor	PCI-Express M.2	MiniCard
	Dimensions		3 x 22.0 x 30.0 mm
			57 x 12.0 x 16.0 mm
	Weight	1. Type 2230: 2.8 2. Type 126: 1.3	-
	Operating Voltage	3.3v +/- 9%	
	Temperature	Operating	14° to 158° F (–10° to 70° C)
		Non-operating	–40° to 176° F (–40° to 80° C)
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating	0 to 10,000 ft (3,048 m)
	Alliuue	Non-operating	0 to 50,000 ft (15,240 m)
	LED Activity	LED Amber – Rac	
		LED Off – Radio (
HP Integrated Module wit	h Bluetooth 4.0/4.1/4.2/5.	0/5.1/5.2/5.3 Wire	eless Technology
	Bluetooth Specification	4.0/4.1/4.2/5.0/	5.1 Compliant/5.2/5.3 Compliant
	Frequency Band	2402 to 2480 MH	łz
	Number of Available	Legacy: 0~79 (1	

BLE: 0~39 (2 MHz/CH)

Channels



Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® XMM™ 7560 R+ LTE-Advanced Pro¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW
	standards	throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output	LTE: 23 dBm in all band except B41
	power	LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
	Maximum power	LTE: 1,200 mA (peak); 900 mA (average)
	consumption	HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g



QuickSpecs

Technical Specifications

Dimensions (Length x Width x Thickness) eSIM 42 x 30 x 2.3 mm

Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Realtek RTL8111HSH 10/100/1000 Integrated NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
	Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface NIC Device Driver Name	PCIe + SMBus Realtek PCIe GBE Ethernet Family Controller



POWER

AC Adapter 45 Watt	Dimensions	94.0 mm x 40.0 mm x 26.5 mm
nPFC Standard USB	Weight	192.5g +/-10%
type C Straight 1.8m	Input	100-240 VAC
	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%
	Input frequency range	47 to 63 Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output	
	Output power	5V/15W 9V/27W 12V/36W 15V/45W
	DC output	5V/9V/12V/15V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<5.0A
	Connector	USB Type-C
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg.
	Certifications	*CE Mark - full compliance with LVD and EMC directives *Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. *MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt **Smart nPFC Standard** Barrel 4.5mm Right Angle 1.8m

Dimensions 95 x 45 x 26.5 mm Weight unit: 200g +/- 10g Input 100-240 VAC **Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230Vac **Input frequency range** 47 ~ 63 Hz **Input AC current** Max. 1.4 A at 90 Vac Output **Output power** 45W **DC** output 19.5V Hold-up time 5ms at 115 Vac input



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	Output current limit	<8.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage)	-4° to 185° F (-20° to 85° C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
		EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1,
		Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
		* MTBF – over 200,000 hours at 25°C ambient condition.
AC Adapter 65 Watt	Dimensions	90.0 x 51 x 28.5mm
nPFC Standard USB	Weight	unit: 250g +/- 10g
type C Straight 1.8m	Input	100-240 VAC
	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with
		115Vac/230Vac Spec:
		5V: 81.5%
		9V: 86.7%
		12V: 88%
		15V: 88% 20V: 89%
	Input frequency range	47 ~ 63Hz
	Input AC current	1.6 A at 90 VAC and maximum load
	Output	
	Output Output power	5V/15W
	σατρατρονεί	9V/27W
		12V/60W
		15V/60W
		20V/65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
	Connector	USB Туре-С
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage)	-4° to 185° F (-20° to 85° C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%



Storage Humidity EMI and Safety Certifications	10% to 95% Eg: *CE Mark - full compliance with LVD and EMC directives
	* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV:
	Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt	Dimensions	102 x 55 x 30mm
Smart nPFC EM Barrel	Weight	unit: 250g +/- 10g
4.5mm New EM	Input	100-240 VAC
	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
	Output	
	Output power	65W
	DC output	19.5V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<11.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32ºF to 95ºF (0ºto 35ºC)
	Non-operating (storage)	-4°F to 185°F (-20°to 85°C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
		EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 ,
		Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC
		Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
		* MTBF - over 200,000 hours at 25°C ambient condition.

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C62368-1,
.62368-1,
)32 Class B, FCC
in.
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RH 51Whr Long Life Polymer Fast Charge 3 cell Battery	Dimensions (H x W x L) Weight Cells/Type Energy	6.50 x 67.80 x 254.00 mm (0.256 x 2.669 x 10 inch) 0.2025 kg (0.446 lb) 3cell Lithium-Ion Polymer cell / 566075
	Voltage	11.58V
	Amp-hour capacity	4.431Ah
	Watt-hour capacity	51.3Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	Follow product spec
	Optional Travel Battery Available	Νο



QuickSpecs

Technical Specifications

AUDIO

HD Stereo Codec	ALC3247-CG
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	ALC 3247 has Embedded Class-D 2W Stereo Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio.
	Following MSFT Behavior
Sampling	DAC:44.1k/48kHz
	ADC:48kHz
Wavetable Syntheses	NA
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	NA
Internal Speaker	Yes

FINGERPRINT READER

Sensor vendor Sensor type	Elan efsa80ST Capacitive
DPI resolution	508 dpi
Scan area	80*80 pixels
False Rejection Rate	<3%
False Acceptance Rate	1/100К
Mobile Voltage Operation	2.7V to 3.6V
Operating Temperature	-4 – 175°F (-20° ~ +80°C)
Current Consumption Image	50mA peak
Low Latency Wait For Finger	900uA
Capture Rate	30 frame/sec
ESD Resistance	+15KV
Detection Matrix	80*80 pixels/ 508 dpi / 4*4mm sensor area



ENVIRONMENTAL DATA

Eco-Label Certifications &	This product has received	or is in the process of being	certified to the following approvals and may	
declarations	be labeled with one or more of these marks:			
	IT ECO declaration			
	US ENERGY STAR			
		y Management Program (FE	MP)	
	EPEAT ^D Gold regis	stered in the United States.	See http://www.epeat.net for registration	
	status in your cou	untry.		
	TCO Certified			
		servation Program (CECP)		
		onmental Protection Admin	istration (SEPA)	
	 Taiwan Green Ma Korea Eco-label 	rk		
	 Japan PC Green la 	ahol*		
Sustainable Impact	Ocean-bound plastic in S			
Specifications	• 10% post-consumer recy			
	Low halogen			
	-	ted cushions are 100% sust	ainably sourced and recyclable	
			inably sourced and recyclable	
	Bulk packaging available			
System Configuration			and Declared Noise Emissions data for the	
-)j	-	on a "Typically Configured N		
Energy Consumption				
(in accordance with US				
ENERGY STAR [®] test				
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Sort				
idle)	5.21 W	5.17 W	5.41 W	
Normal Operation (Long				
idle)	0.91 W	1.01 W	0.92 W	
Sleep	0.91 W	1.01 W	0.92 W	
Off	0.29 W	0.31 W	0.29 W	
	NOTE:			
	Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model			
	family. HP computers mar	ked with the ENERGY STAR®	⁹ Logo are compliant with the applicable U.S.	
	Environmental Protection Agency (EPA) ENERGY STAR [®] specifications for computers. If a mode family does not offer ENERGY STAR [®] compliant configurations, then energy efficiency data list			
is for a typically configured PC featuring a hard disk drive, a high efficiency power su			drive, a high efficiency power supply, and a	
	Microsoft Windows® operating system.			
11				
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short		17 7 DTU //		
idle)	17.8 BTU/hr	17.7 BTU/hr	18.5 BTU/hr	
		1		
Normal Operation (Long				
Normal Operation (Long idle)	3.1 BTU/hr	3.5 BTU/hr	3.1 BTU/hr	
Normal Operation (Long	3.1 BTU/hr 3.1 BTU/hr 1 BTU/hr	3.5 BTU/hr 3.5 BTU/hr 1.1 BTU/hr	3.1 BTU/hr 3.1 BTU/hr 1 BTU/hr	



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Technical Specifications

	* NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.			
Declared Noise Emissions		Sound Power	Sound Pr	ressure
(in accordance with ISO 7779 and ISO 9296)	(L _{wAd} , bels)			cibels)
Typically Configured – Idle		2.6	15.	.4
Fixed Disk – Random writes		2.7	15.	
Optical Drive – Sequential reads		3.2	29.	.8
Longevity and Upgrading		can be upgraded, possibly e /or components contained i	xtending its useful life by seve 1 the	eral years. Upgradeable
	Spare parts a of production		warranty period and or for up	to "5" years after the end
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. This product is 93.3% recycle-able when properly disposed of at end of life. 			
Packaging Materials	External:	PAPER/Corrugated		0.295 g
		PAPER/Molded Pulp		0.192 g
	Internal:	PLASTIC/Polyethylene lov	v density - LDPE	0.010 g
	The plastic p	backaging material contains	at least 0.0% recycled conten	t.
	-		als contains at least 60.6% rec	
RoHS Compliance	HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see Error! Hyperlink reference not valid. HP RoHS position statement.			
Material Usage	(refer to the	HP General Specification for	following substances in exces the Environment at ship/environment/supplychai	



):
	Asbestos
	Certain Azo Colorants
	• Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
	Cadmium
	Chlorinated Hydrocarbons
	Chlorinated Paraffins
	Bis(2-Ethylhexyl) phthalate (DEHP)
	Benzyl butyl phthalate (BBP)
	Dibutyl phthalate (DBP)
	Diisobutyl phthalate (DIBP)
	Formaldehyde
	Halogenated Diphenyl Methanes
	Lead carbonates and sulfates
	Lead and Lead compounds
	Mercuric Oxide Batteries
	Nickel – finishes must not be used on the external surface designed to be frequently
	handled or carried by the user.
	Ozone Depleting Substances Delubraria de Biele anula (DDD-)
	Polybrominated Biphenyls (PBBs) Delubrominated Biphenyl Ethers (DBBEs)
	 Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs)
	 Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT)
	 Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has
	been voluntarily removed from most applications.
	Radioactive Substances
	 Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	Design packaging materials for ease of disassembly.
	• Maximize the use of post-consumer recycled content materials in packaging materials.
	• Use readily recyclable packaging materials such as paper and corrugated materials.
	Reduce size and weight of packages to improve transportation fuel efficiency.
	• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	HP offers end-of-life HP product return and recycling programs in many geographic areas. To
and Recycling	recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest
	HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible
	manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information
	for each product type for use by treatment facilities. This information (product disassembly
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.
	These instructions may be used by recyclers and other WEEE treatment facilities as well as HP
	OEM customers who integrate and re-sell HP equipment.



QuickSpecs

Technical Specifications

HP,	Inc.	Corporate	For more information about HP's commitment to the environment:
•	nmental nation		Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footno	ites		 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1- 2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials.

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

Docking station model #1HP USB-C Dock G5Total number of supported displays (incl. the notebook display) Max. resolutions supported3Dual 5K@ 30Hz + 1 4K UHD (multi-function mode) 5120x2880 Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Dock Connectors1xHDMI, 2xDPTechnical limitationsHighest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
(incl. the notebook display) Max. resolutions supportedJual 5K@ 30Hz + 1 4K UHD (multi-function mode) 5120x2880 Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Dock Connectors Technical limitations1xHDMI, 2xDP Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Dock Connectors1xHDMI, 2xDPTechnical limitationsHighest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
Dock Connectorsmode.Technical limitations1xHDMI, 2xDPHighest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
Technical limitationsHighest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
4K UHD@ 30 Hz on HDMI in Multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
Docking station model #2 HP USB-C/A Universal Dock G2
Total number of supported displays (incl. the notebook display)
Max. resolutions supported Triple 4K UHD@ 60Hz 3840x2160
Dock Connectors1xHDMI, 2xDP
Technical limitationsThe best resolution for dual or triple displays is 4K UHD@ 60Hz.For use with the USB-A adapter that comes in the box the maximum numberof displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection fromthe host
Docking station model #3 HP Thunderbolt Dock G2
Total number of supported displays (incl. the notebook display)
Max. resolutions supported Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported Single 8K@ 60Hz for Thunderbolt hosts or USB-C hosts DP 1.4 with DSC in high res mode.
Dock Connectors 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Technical limitations Thunderbolt Hosts:
Maximum of (4) displays with maximum resolution of 5K@ 30Hz running
Thunderbolt host.
Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz
Non-Thunderbolt hosts:
The highest resolution for dual displays running a non-Thunderbolt host in
multi-function mode is
(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port
Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2)
5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi- function mode the maximum resolution for (2) displays is (2) EK single cable
function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.



Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Business Slim 17.3 Top Load	2UW02AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive 17.3 Backpack	6KD05AA
	HP Executive 17.3 Top Load	6KD08AA
	HP Executive Leather 15.6 Top Load	6KD09AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP USB-C Dock G5	5TW10AA
11h		1046444
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
•	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA



QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

•		
	HP 235 Wireless Mouse and Keyboard Combo	1Y4DOAA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1DOK2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm LC Smart non-EM India Ony AC Power Adapter	3FF84AA#ACJ
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
commonly		1AJ39AA
	HP Nano Keyed Cable Lock HP Nano Master Keyed Cable Lock	1AJ39AA 1AJ40AA
	HP Nano Master Reyeu Cable Lock HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
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Summary of Changes

Date of change:	Version History:	Updated	Description of change:
March 28, 2022	V1 to V2	Added	Environmental Data
April 11, 2022	V2 to V3	Added	Reference for USB ports
June 15, 2022	V3 to V4	Added	Added note in Manageability Feature
June 22, 2022	V4 to V5	Updated	Discrete in Graphics section
July 19, 2022	V5 to V6	Added	Input value in Power section
August 8, 2022	V6 to V7	Updated	DisplayPort™ in At a Glance and Ports/Slots section
September 7, 2022	V7 to V8	Removed	Tile App
October 20, 2022	V8 to V9	Updated	Bluetooth version
December 8, 2022	V9 to V10	Updated	Windows OS
January 12, 2023	V10 to V11	Added	HP Client Security Manager in Software and Security section
January 20, 2023	V11 to V12	Updated	Operating System

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